DEVICE, AND ELECTRONIC EQUIPMENT
Inventors: Tetsuya OTSUKI, Hirofumi KUROSAWA, Hiroshi MIKI
Atty. Ref.: 9319I-000714

FIG. 1A

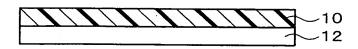


FIG. 1B

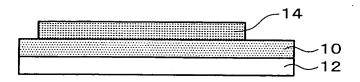


FIG. 1C

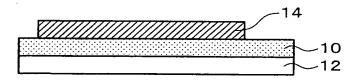
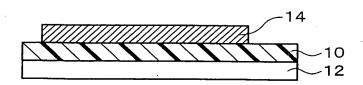


FIG. 1D



Title: WIRING BOARD, METHOD OF MANUFACTURING THE SAME, SEMICONDUCTOR DEVICE, AND ELECTRONIC EQUIPMENT

Inventors: Tetsuya OTSUKI, Hirofumi KUROSAWA, Hiroshi MIKI Atty. Ref.: 9319I-000714

FIG. 2A

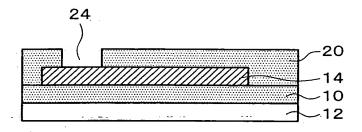


FIG. 2B

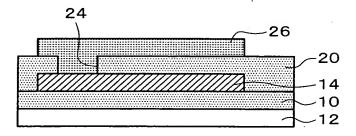
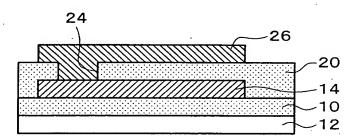


FIG. 2C



Title: WIRING BOARD, METHOD OF MANUFACTURING THE SAME, SEMICONDUCTOR DEVICE, AND ELECTRONIC EQUIPMENT

Inventors: Tetsuya OTSUKI, Hirofumi KUROSAWA, Hiroshi MIKI Atty. Ref.: 9319I-000714

FIG. 3A

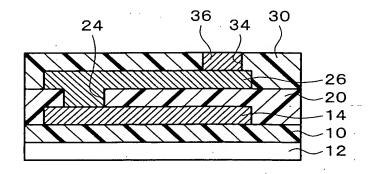
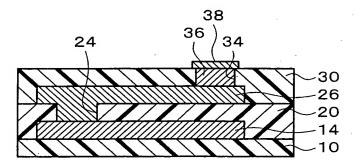


FIG. 3B



Title: WIRING BOARD, METHOD OF MANUFACTURING THE SAME, SEMICONDUCTOR DEVICE, AND ELECTRONIC EQUIPMENT

Inventors: Tetsuya OTSUKI, Hirofumi KUROSAWA, Hiroshi MIKI Atty. Ref.: 9319I-000714

FIG. 4A

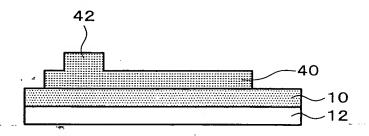


FIG. 4B

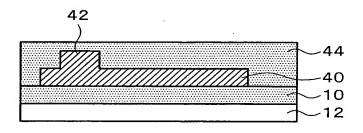


FIG. 4C

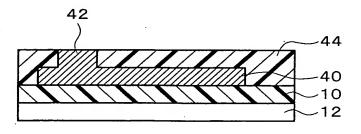
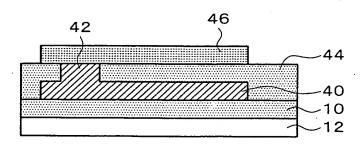


FIG. 4D



Title: WIRING BOARD, METHOD OF MANUFACTURING THE SAME, SEMICONDUCTOR DEVICE, AND ELECTRONIC EQUIPMENT Inventors: Tetsuya OTSUKI, Hirofumi KUROSAWA, Hiroshi MIKI Atty. Ref.: 9319I-000714

FIG. 5A

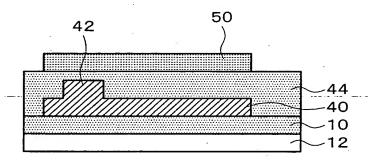


FIG. 5B

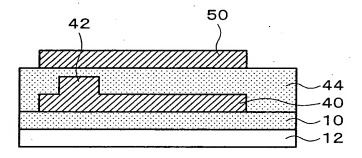
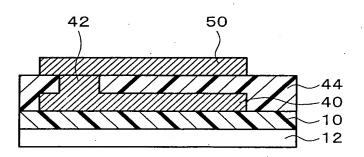


FIG. 5C



DEVICE, AND ELECTRONIC EQUIPMENT

Inventors: Tetsuya OTSUKI, Hirofumi KUROSAWA, Hiroshi MIKI

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FIG. 6A



FIG. 6B

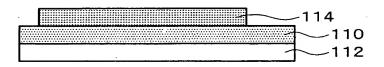


FIG. 6C

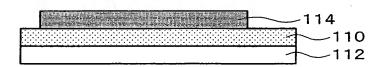
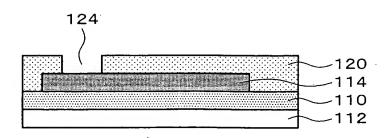


FIG. 6D



DEVICE, AND ELECTRONIC EQUIPMENT

Inventors: Tetsuya OTSUKI, Hirofumi KUROSAWA, Hiroshi MIKI Atty. Ref.: 9319I-000714

FIG. 7A

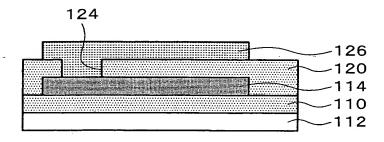


FIG. 7B

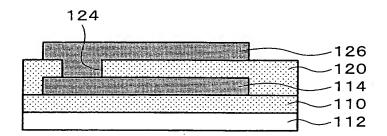
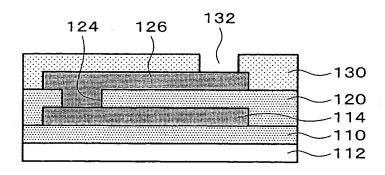


FIG. 7C



Title: WIRING BOARD, METHOD OF MANUFACTURING THE SAME, SEMICONDUCTOR

DEVICE, AND ELECTRONIC EQUIPMENT
Inventors: Tetsuya OTSUKI, Hirofumi KUROSAWA, Hiroshi MIKI

Atty. Ref.: 9319I-000714

FIG. 8A

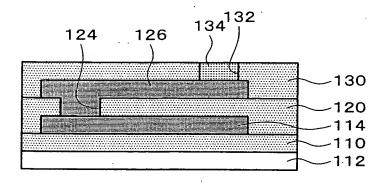


FIG. 8B

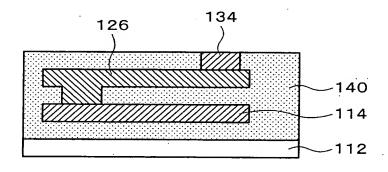
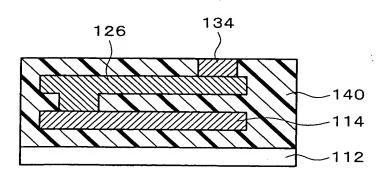


FIG. 8C



Title: WIRING BOARD, METHOD OF MANUFACTURING THE SAME, SEMICONDUCTOR DEVICE, AND ELECTRONIC EQUIPMENT
Inventors: Tetsuya OTSUKI, Hirofumi KUROSAWA, Hiroshi MIKI
Atty. Ref.: 9319I-000714

FIG. 9A

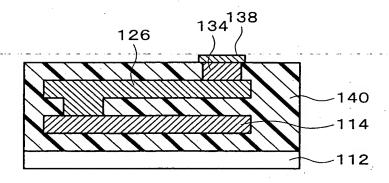
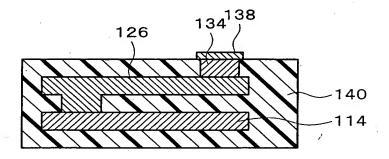


FIG. 9B



DEVICE, AND ELECTRONIC EQUIPMENT

Inventors: Tetsuya OTSUKI, Hirofumi KUROSAWA, Hiroshi MIKI Atty. Ref.: 9319I-000714

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FIG. 10A

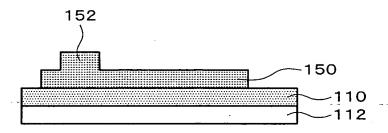


FIG. 10B

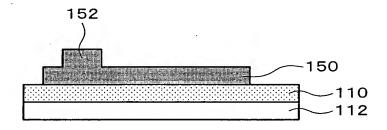
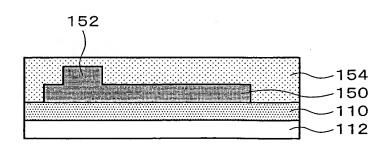


FIG. 10C



DEVICE, AND ELECTRONIC EQUIPMENT

Inventors: Tetsuya OTSUKI, Hirofumi KUROSAWA, Hiroshi MIKI

Atty. Ref.: 9319I-000714

FIG. 11A

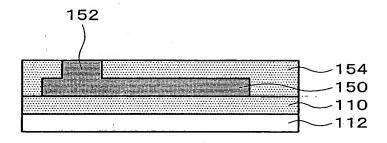


FIG. 11B

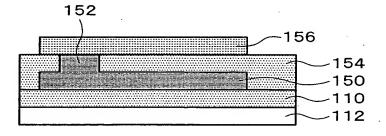
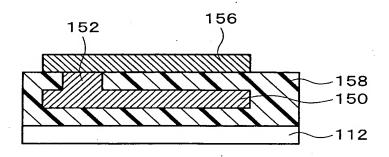


FIG. 11C



DEVICE, AND ELECTRONIC EQUIPMENT

Inventors: Tetsuya OTSUKI, Hirofumi KUROSAWA, Hiroshi MIKI

Atty. Ref.: 9319I-000714

FIG. 12A

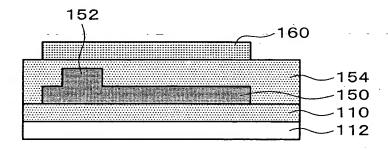
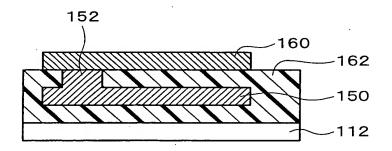


FIG. 12B



Title: WIRING BOARD, METHOD OF MANUFACTURING THE SAME, SEMICONDUCTOR DEVICE, AND ELECTRONIC EQUIPMENT Inventors: Tetsuya OTSUKI, Hirofumi KUROSAWA, Hiroshi MIKI Atty. Ref.: 9319I-000714

FIG. 13

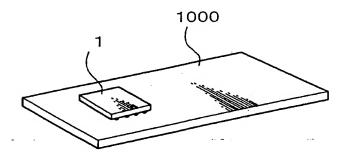


FIG. 14

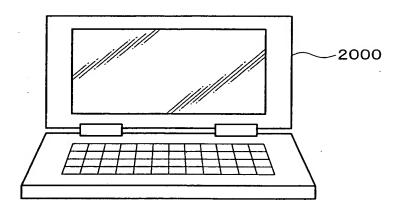


FIG. 15

